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Attorney Docket No. ONDAT-017US

## Appendix A

- 2. (Amended) The hot plate according to claim 1, characterized in that the conductive layer <u>further</u> includes [ruthenium oxide, ] bismuth or its oxide [, glass frit, and noble metal grains].
- 3. (Amended) The hot plate according to claim 1 [or 2], characterized in that the ceramic substrate is a ceramic substrate is a ceramic nitride substrate or a ceramic carbide base plate.
- 4. (Amended) The hot plate according to [any one of claims 1 to 3] <u>claim 1</u>, wherein the glass frit includes zinc boron silicate.
- 5. (Amended) The hot plate according to [any one of claims 1 to 4] <u>claim 1</u>, wherein the noble metal grains is at least one selected from gold grains, silver grains, platinum grains, and palladium grains.
- 8. (New) A hot plate that uses a ceramic substrate provided with a conductive layer, wherein the hot plate characterized in that the conductive layer includes ruthenium oxide, bismuth or its oxide, glass frit, and noble metal grains, wherein the ceramic substrate is a ceramic nitride substrate or a ceramic carbide base plate..
- 9. (New) The hot plate according to claim 8, wherein the glass frit includes zinc boron silicate.
- 10. (New) The hotplate according to claim 8, wherein the noble metal grains is at least one selected from gold grains, silver grains, platinum grains, and palladium grains.
- 11. (New) The hot plate according to claim 10, wherein the glass frit includes zinc boron silicate.